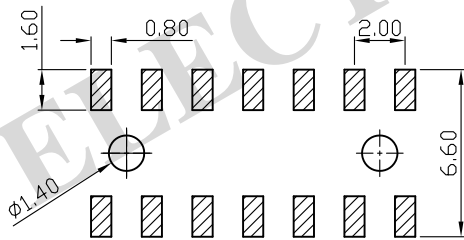
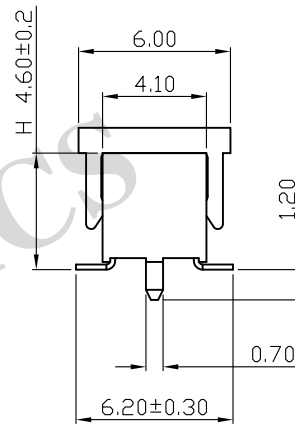
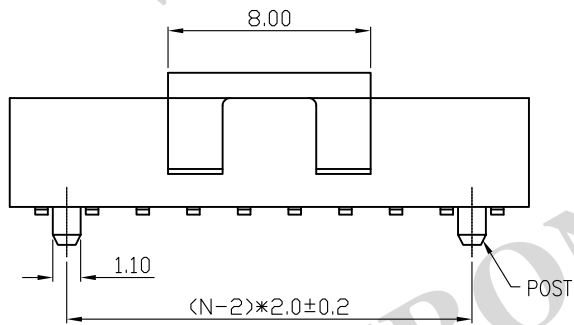
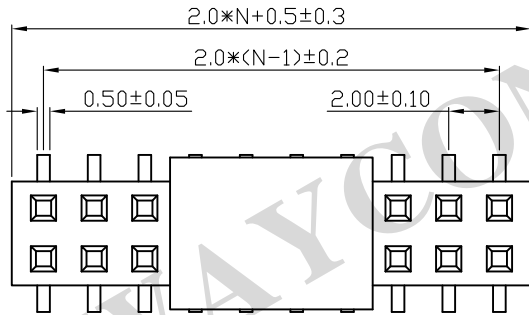


N: NUMBER OF CONTACTS/2



RECOMMEND PCB LAYOUT  
(TOLERANCE=±0.05)

1. MATERIAL

- 1.1 INSULATOR: THERMOPLASTIC (UL 94V-0).
- 1.2 CONTACT MATERIAL: COPPER ALLOY.

2. SPECIFICATION

- 2.1 CURRENT RATING: 1.5 Amp.
- 2.2 INSULATION RESISTANCE: 1000mΩ Min.
- 2.3 DIELECTRIC WITHSTANDING: 600VAC.
- 2.4 CONTACT RESISTENCE: 20mΩ Max.
- 2.5 OPERATING TEMPERATURE: -40°C TO +105°C.

3. PLASTIC WITHSTAND TEMP

- 3.1 MAX PROCESSING TEMP:  
180°C FOR 30-60 SEC; (200°C FOR 5-10 SEC.) - PBT  
230°C FOR 30-60 SEC; (260°C FOR 5-10 SEC.) - PA6T

**FH 200 - XXX - XXX GX**

Gender

P=Pin Header  
F=Female Header

Pitch

0.80=080  
1.00=100  
1.27=127  
2.00=200  
2.54=254

No. of PINS

1 x 01 ~ 1 x 40 PINS  
2 x 01 ~ 2 x 40 PINS  
3 x 01 ~ 3 x 40 PINS

Connector Type

S=Straight  
R=Right Angle  
M=SMT

Plating

G0: Gold Flash  
G2: 1U" Gold  
G3: 3U" Gold  
G4: 5U" Gold  
G5: 10U" Gold  
G6: 15U" Gold  
SN: Tin

Packing Style

1. Loose in Bag  
2. Tape & Reel  
3. Tube

Insulator Material

1: PBT  
2: PA6T  
3: PA9T  
4: LCP

PRODUCT TITLE:	2.00mm SMT Header Socket, Dual Row, Width: 4.1mm		
UNLESS OTHERWISE SPECIFIED TOLERANCES	SCALE: 1/1	UNIT: mm	 FH200-2XX-MXXG0-09 Cap & Post Optional
	SIZE: A3	PAGE: 1 OF 1	
DECIMALS:	ANGLES:	<b>WAYCONN ELECTRONICS</b>	
X :±0.5	X :±6°		
X.X :±0.3	X.X :±3°		
X.XX :±0.2	X.XX :±2°		